



# SV7330E

8KV ESD, Low Ron, Wide Bandwidth, Low Power,  
Quad SPDT Video Switch

v0.97  
**SAVITECH Corporation**

# SV7330E

8KV ESD, Low Ron, Wide Bandwidth, Low Power,  
Quad SPDT Video Switch

## Features

- Seamless Bidirectional Data Switching
- Roboust ESD protection: HBM 8KV
- Low Turn-On Resistance:  $4.5\Omega$  ( $V_{CC}=5V$ )
- Wide Bandwidth: -3dB BW = 480MHz
- High Off Isolation: -60dB
- Extreme Low Power Consumption: 0.4uA
- Single Vcc Supply: +1.8V ~ +5V
- Vcc Supply Accuracy: +/-10%
- Control Input Pins are compatible with TTL and 5V/3.3V CMOS
- Pb-free & Green Package: QSOP-16, SOP-16, TSSOP-16

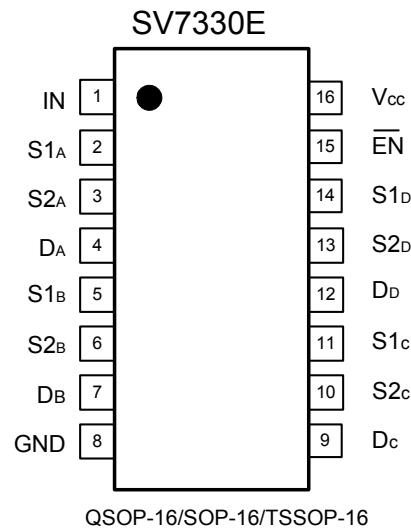
## Description

The SV7330E is a high quality, low power, high-speed analog video switch. It features wide bandwidth, low turn-on resistance and low crosstalk that make it ideal for seamless composite and RGB SD and HD video switching applications.

It can also function as a 4-bit 1-of-2 MUX/DEMUX for other high-speed data switching applications. A single switch-enable ( $\bar{EN}$ ) input is used to enable or disable the switch. When  $\bar{EN}$  is set at logic 'L', the D-port is connected to the S-port that shows low-Ron between D-port and S-port that enables the switch. When  $\bar{EN}$  is set at logic 'H', the high-impedance state exists between the D and S ports that disable the switch. The select (IN) pin controls the input data path of the MUX/DEMUX. The device spec at high off-isolation, so it will maintain isolation during power down.

It is powered by a single +1.8 to +5V rail typically and consumes extremely low power.

## Pin connection



QSOP-16/SOP-16/TSSOP-16

## Pin Description

PIN	DESCRIPTION
S1,S2	Analog video I/Os
D	Analog video
IN	IN Select input
$\bar{EN}$	Switch-enable input

## Function Table

INPUTS		INPUT/OUTPUT D	FUNCTION
EN	IN		
L	L	S1	D port = S1 port
L	H	S2	D port = S2 port
H	X	Z	Disconnected

## Ordering Information

Ordering Code	Operation Range	Package	Packing
SV7330E-16QP-TR2	-40°C ~ +85°C	QSOP-16L	Tape & Reel, 2500pcs
SV7330E-16SP-TR2	-40°C ~ +85°C	SOP-16	Tape & Reel, 2500pcs
SV7330E-16TP-TR3	-40°C ~ +85°C	TSSOP-16	Tape & Reel, 3000pcs

Note:

SV  
↓      ↓  
SAVITECH Part Number

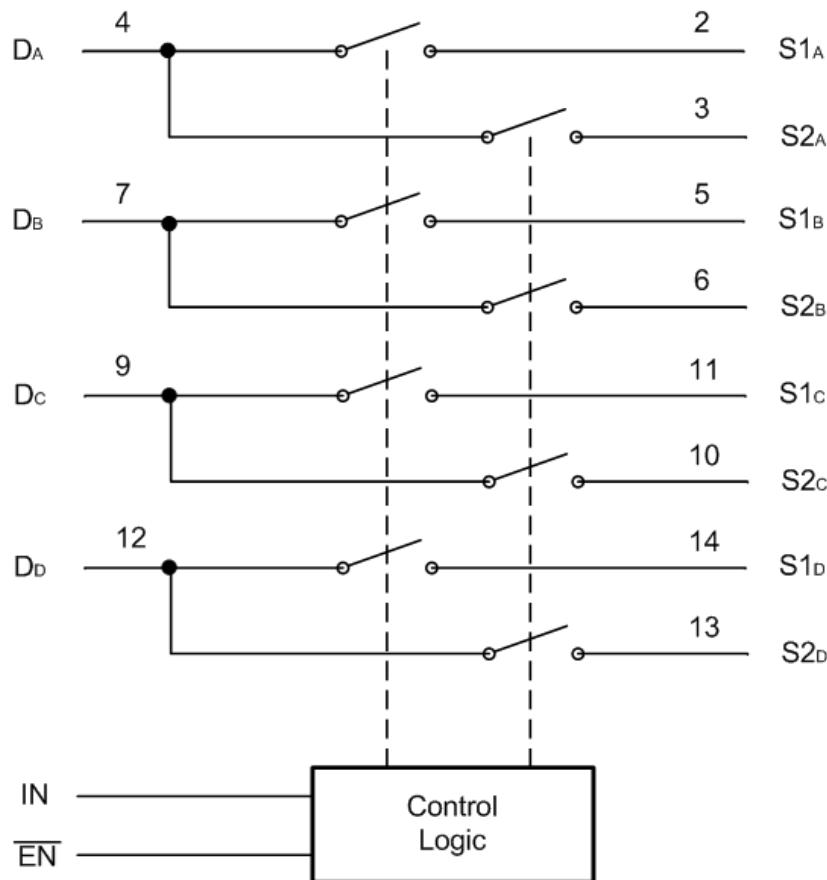
7330E  
↓      ↓  
Package      Shipping

16QP: QSOP-16L      TR2: Tape & Reel, 2500pcs

16SP: SOP-16      TR3: Tape & Reel, 3000pcs

16TP: TSSOP-16

## Function Diagram



## Absolute maximum ratings

Parameter	Value	Unit
V <sub>CC</sub> to GND, Supply Voltage,	7	V
Input Voltage	GND - 0.3 to (V <sub>CC</sub> ) +0.3	V
Storage Temperature Range	-65 to +150	°C
Continuous current through V <sub>DD</sub> or GND	100	mA
ESD Susceptibility: HBM	>8000	V
ESD Susceptibility: MM	400	V

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SAVITECH recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

**Electrical characteristics**(V<sub>CC</sub> = +4.5V, GND = 0V, T<sub>A</sub> = +25°C unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>DC CHARACTERISTICS</b>						
On-Resistance	R <sub>ON</sub>	V <sub>CC</sub> = 4.5V, V <sub>IN</sub> =0V, I <sub>D</sub> =26mA		5.5		Ω
		V <sub>CC</sub> = 4.5V, V <sub>IN</sub> =2V, I <sub>D</sub> = 26mA		7.5		Ω
		V <sub>CC</sub> = 4.5V, V <sub>IN</sub> =4.5V, I <sub>D</sub> = 26mA		19		Ω
Input High Voltage	V <sub>IH</sub>	V <sub>CC</sub> = 5.0V	V <sub>DD</sub> * 0.6	2.34	V <sub>DD</sub> * 0.4	V
Input Low Voltage	V <sub>IL</sub>	V <sub>CC</sub> = 5.0V		2.33	0.5	V
Input High Current	I <sub>IH</sub>	V <sub>CC</sub> = 5.5V, V <sub>IN</sub> and V <sub>EN</sub> = V <sub>CC</sub>		±1	2.5	μA
Input Low Current	I <sub>IL</sub>	V <sub>CC</sub> = 5.5V, V <sub>IN</sub> and V <sub>EN</sub> = 0V		±1	2.5	μA
Analog Output Leakage Current	I <sub>O</sub>	V <sub>CC</sub> = 5.5V, V <sub>S1</sub> or V <sub>S2</sub> = 0.3V/1.2V, V <sub>D</sub> = 1.2V/0.3V		±1		μA
Clamp Diode Voltage	V <sub>IK</sub>	I <sub>IN</sub> = -1.8mA		-0.78		V
<b>DYNAMIC CHARACTERISTICS</b>						
Turn-On Time	T <sub>ON</sub>	R <sub>L</sub> = 75Ω, C <sub>L</sub> = 20pF		22		ns
Turn-Off Time	T <sub>OFF</sub>			4.8		ns
Off Isolation	O <sub>ISO</sub>	Sync in 1080i 60Hz schema, DC couple		-60.8		dB
		2T pulse in 1080i 60Hz schema, DC couple		-59.0		dB
Channel- to Channel Crosstalk	X <sub>TALK</sub>	f = 10MHz		-66.0		dB
–3dB Bandwidth	BW			480		MHz
Input/Enable Capacitance	C <sub>IN</sub>	f = 1MHz		4		pF
Differential Gain	D <sub>G</sub>	V <sub>CC</sub> =5.0V, 5 Step Modulation Pattern in PAL schema		0.64		% p-p
Differential Phase	D <sub>P</sub>	V <sub>CC</sub> =5.0V, 5 Step Modulation Pattern in PAL schema		0.15		% deg.
<b>POWER REQUIREMENTS</b>						
Power Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 5.5V, V <sub>IN</sub> = 0V or V <sub>CC</sub>		0.4	3	μA
Supply Current per Input @ TTL HIGH	ΔI <sub>CC</sub>	V <sub>CC</sub> = 5.5V, V <sub>IN</sub> = 3.4V			2.5	mA

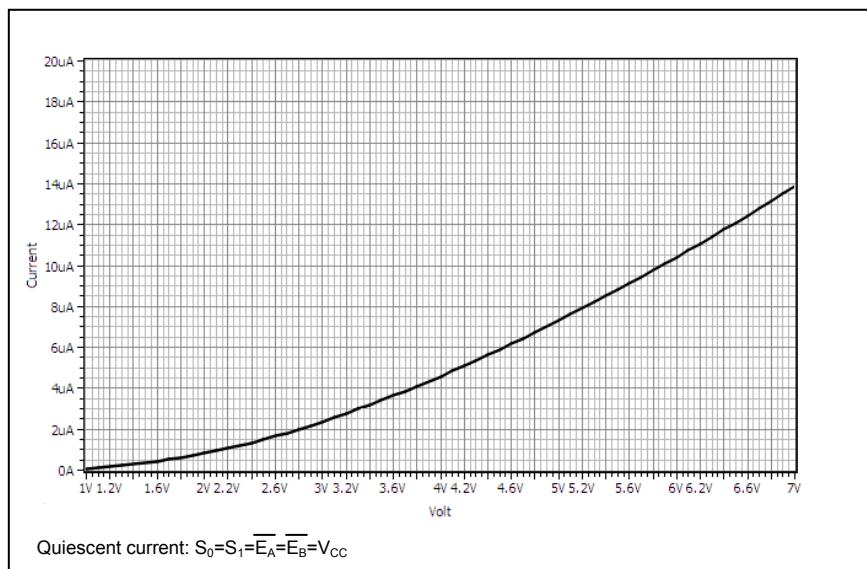
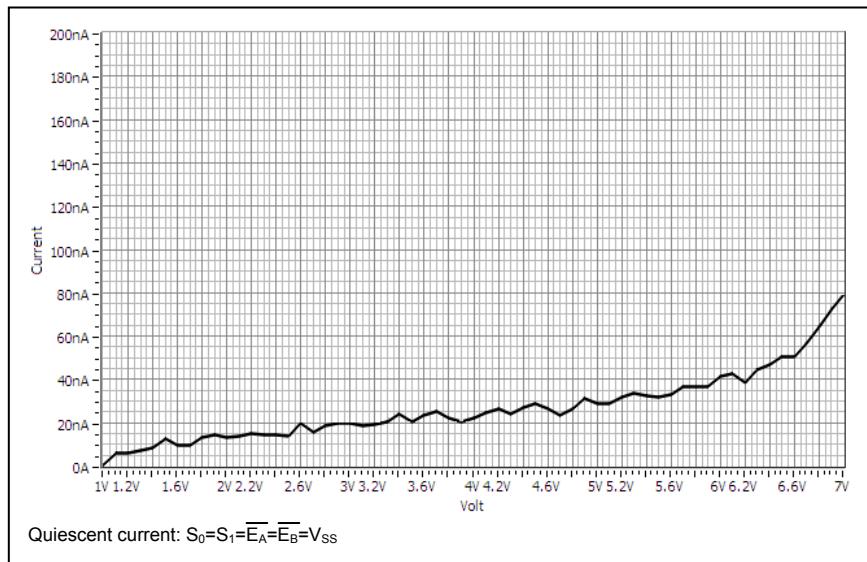
Specifications are subject to change without notice.

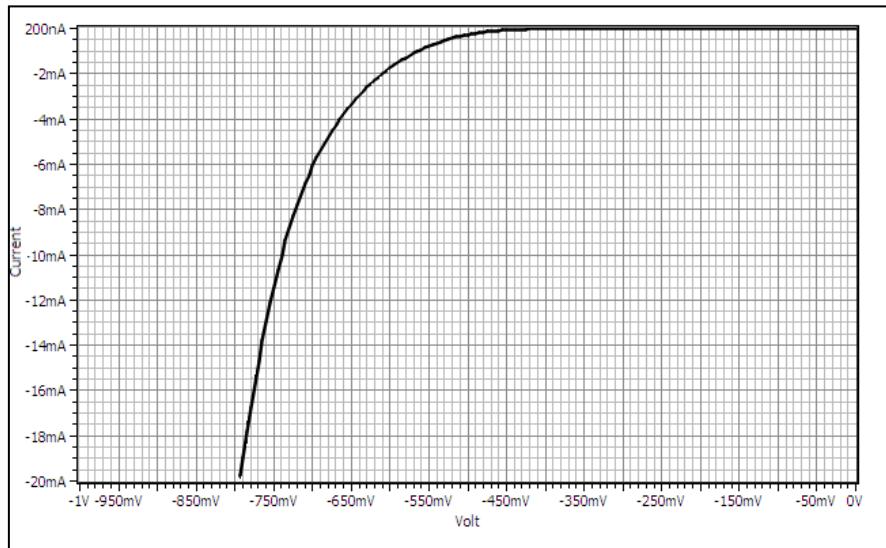
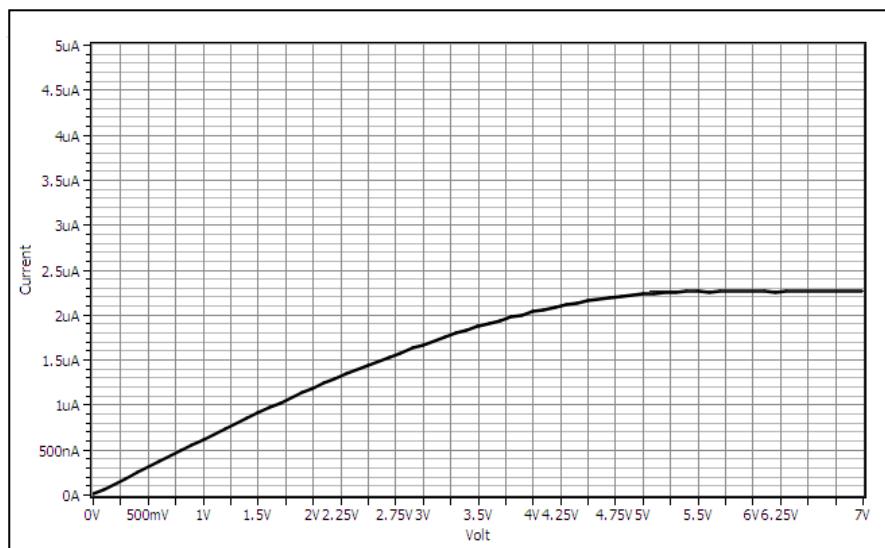
PARAMETER	DESCRIPTION
<b>R<sub>ON</sub></b>	Resistance between source and drain with switch in the ON state
<b>I<sub>O</sub></b>	Output leakage current measured at S1, S2, and D with the switch OFF
<b>V<sub>IN</sub></b>	Digital voltage at the IN pin that selects between S1 and S2 analog inputs
<b>V<sub>I</sub></b>	Voltage applied to the D or S1, S2 pins when D or S1, S2 is the switch input
<b>V<sub>IK</sub></b>	A Clamp Diode Voltage Drop
<b>C<sub>IN</sub></b>	Capacitance at the digital inputs
<b>C<sub>OFF</sub></b>	Capacitance at analog I/O (S1, S2, D) with switch OFF
<b>C<sub>ON</sub></b>	Capacitance at analog I/O (S1, S2, D) with switch ON
<b>V<sub>IH</sub></b>	Minimum input voltage for logic HIGH
<b>V<sub>IL</sub></b>	Minimum input voltage for logic LOW
<b>I<sub>IH (IL)</sub></b>	Input current of the digital input
<b>T<sub>ON</sub></b>	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned ON.
<b>T<sub>OFF</sub></b>	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned OFF.
<b>BW</b>	response of the switch in the ON state measured at 3dB down
<b>D<sub>G</sub></b>	Magnitude variation between analog input and output pins when the switch is ON and the dc offset of composite-video signal varies at the analog input pin. In the PAL standard, the frequency of the video signal is 4.43MHz.
<b>D<sub>P</sub></b>	Phase variation between analog input and output pins when the switch is ON and the dc offset of composite-video signal varies at the analog input pin. In the PAL standard, the frequency of the video signal is 4.43MHz.
<b>O<sub>ISO</sub></b>	Off isolation is the resistance (measured in 100IRE 2T 1080i pulse) between the input and output with the switch off (NO)

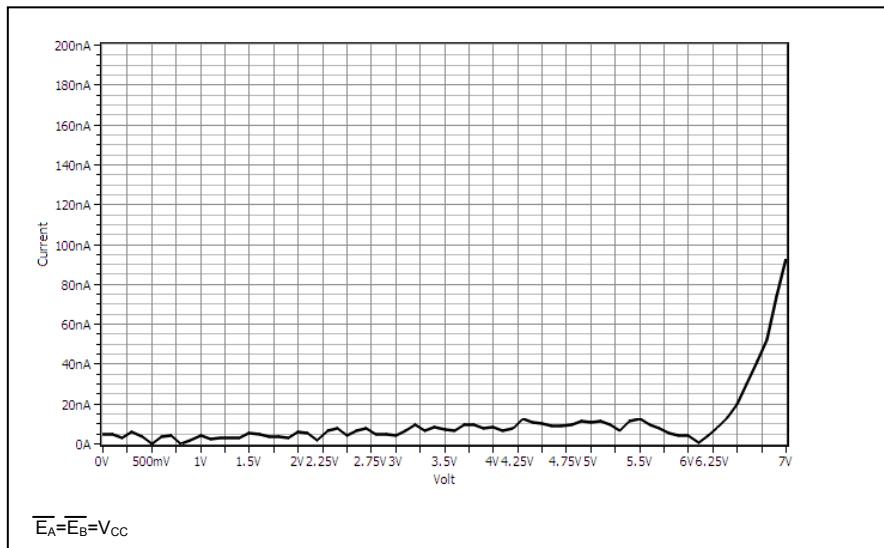
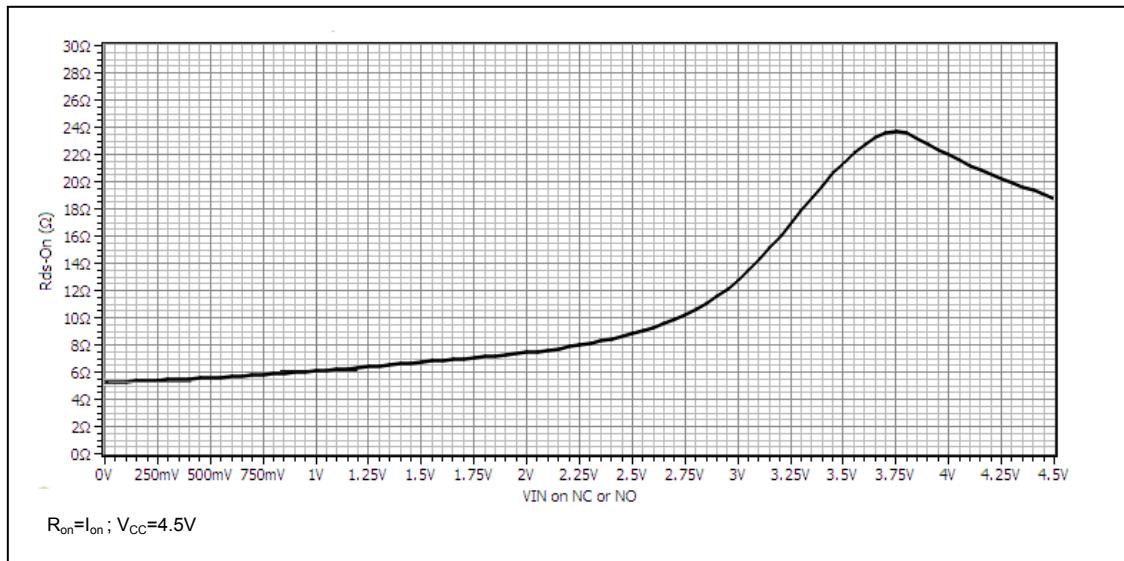
## Typical Performance Characteristics

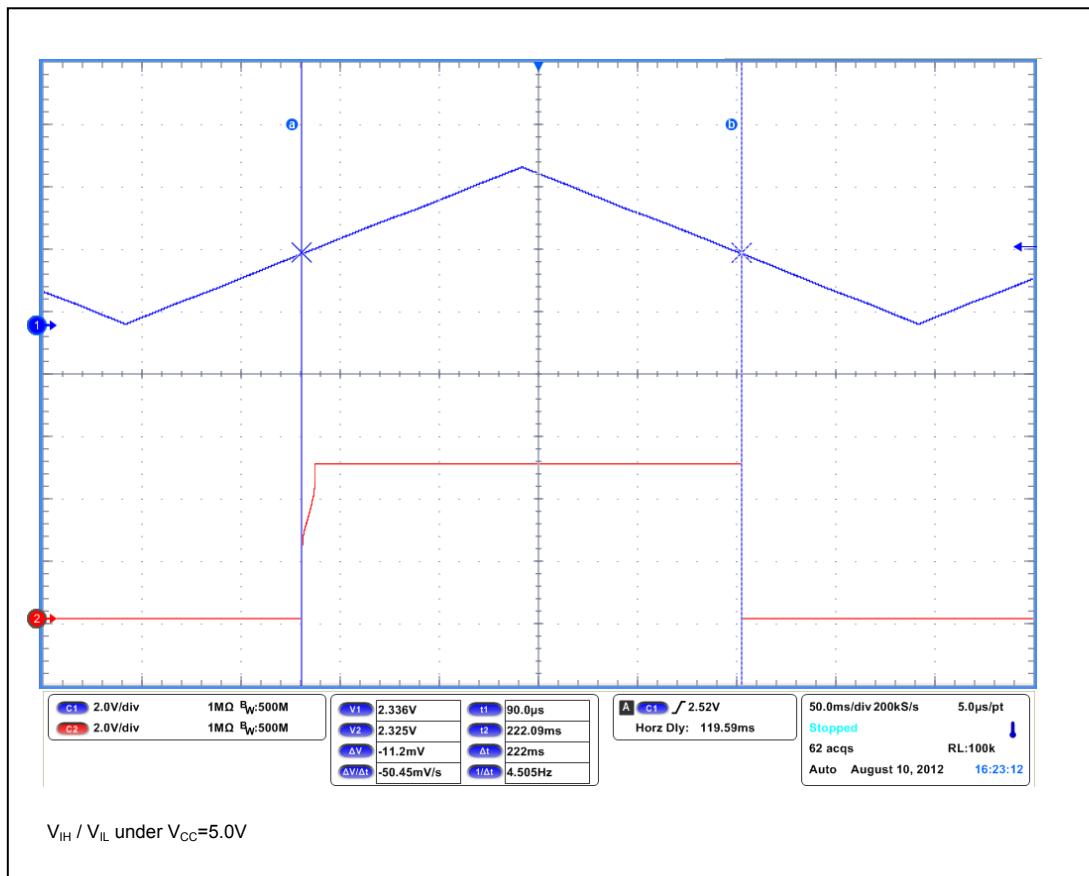
### DC ELECTRICAL CHARACTERISTICS

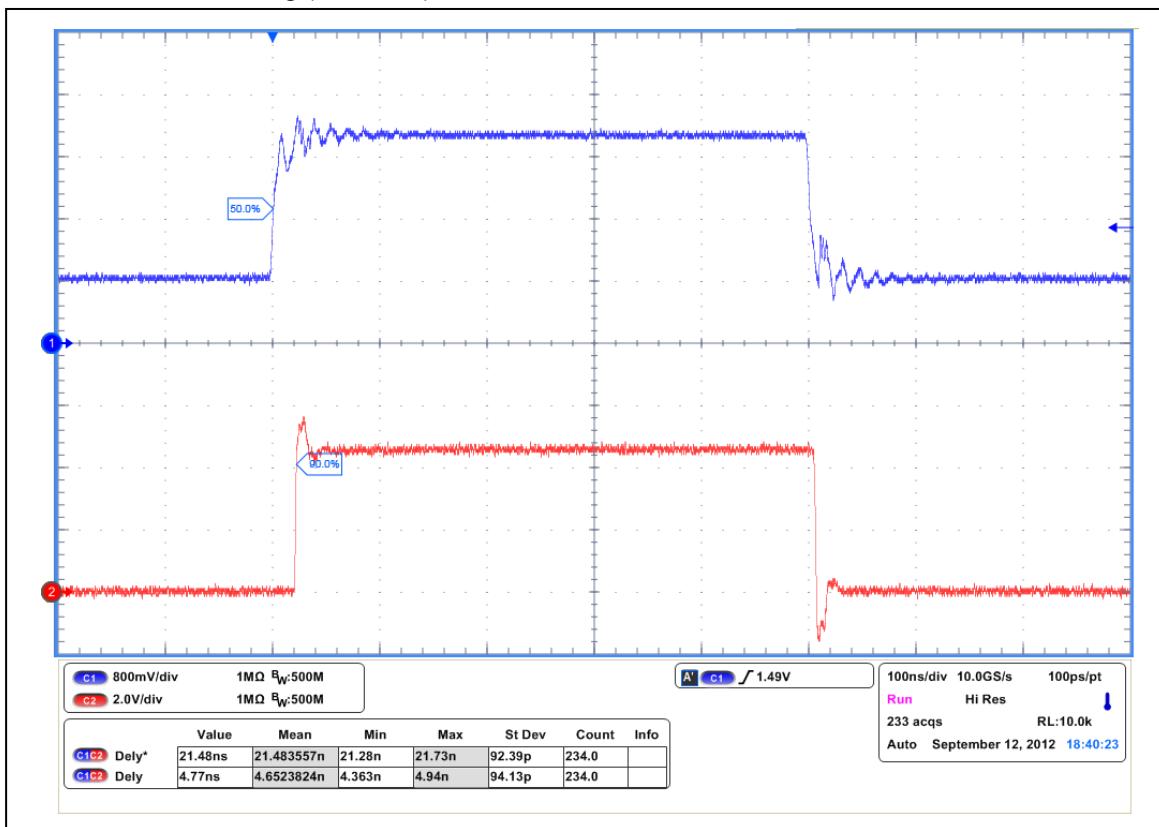
Quiescent Power Supply Current ( $I_{CC}$ )



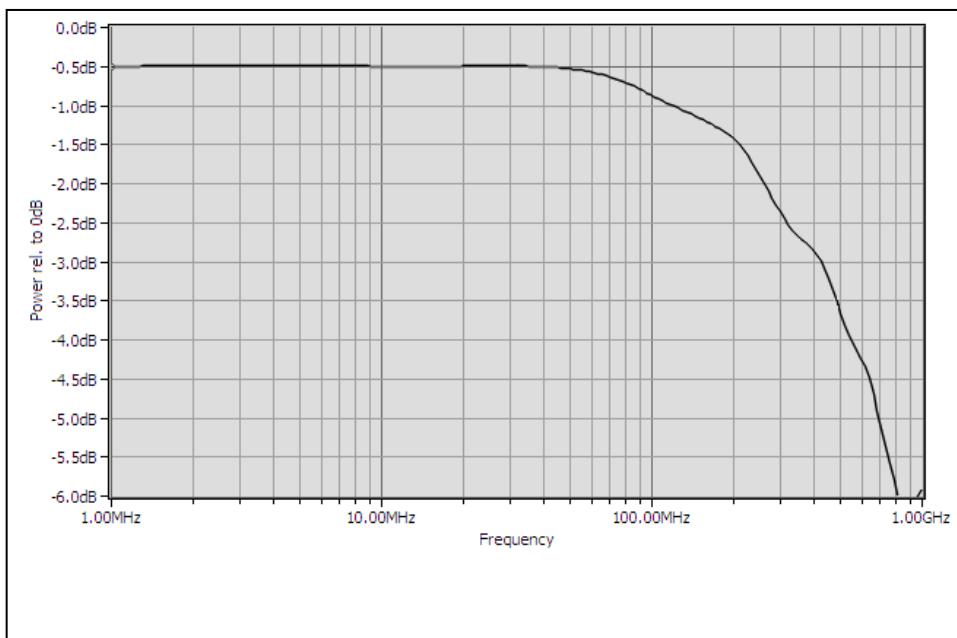
Clamp Diode Voltage ( $V_{IK}$ )Control Input Leakage ( $I_{IH}$  and  $I_{IL}$ ) for  $\overline{S0}$ ,  $\overline{S1}$ ,  $E_A$  and  $E_B$ 

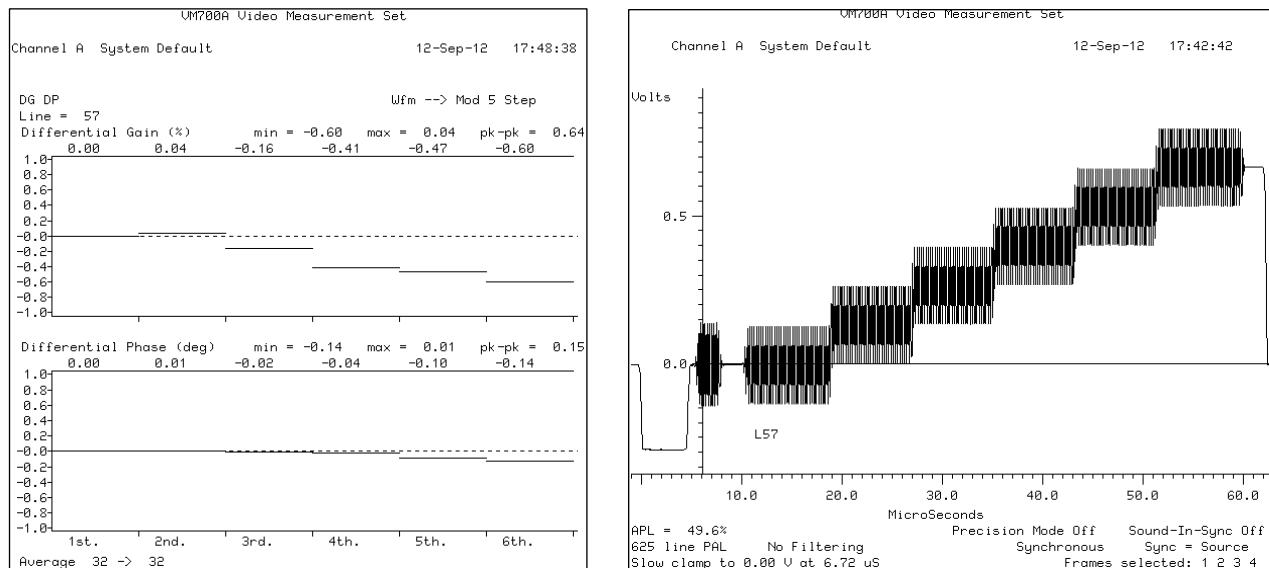
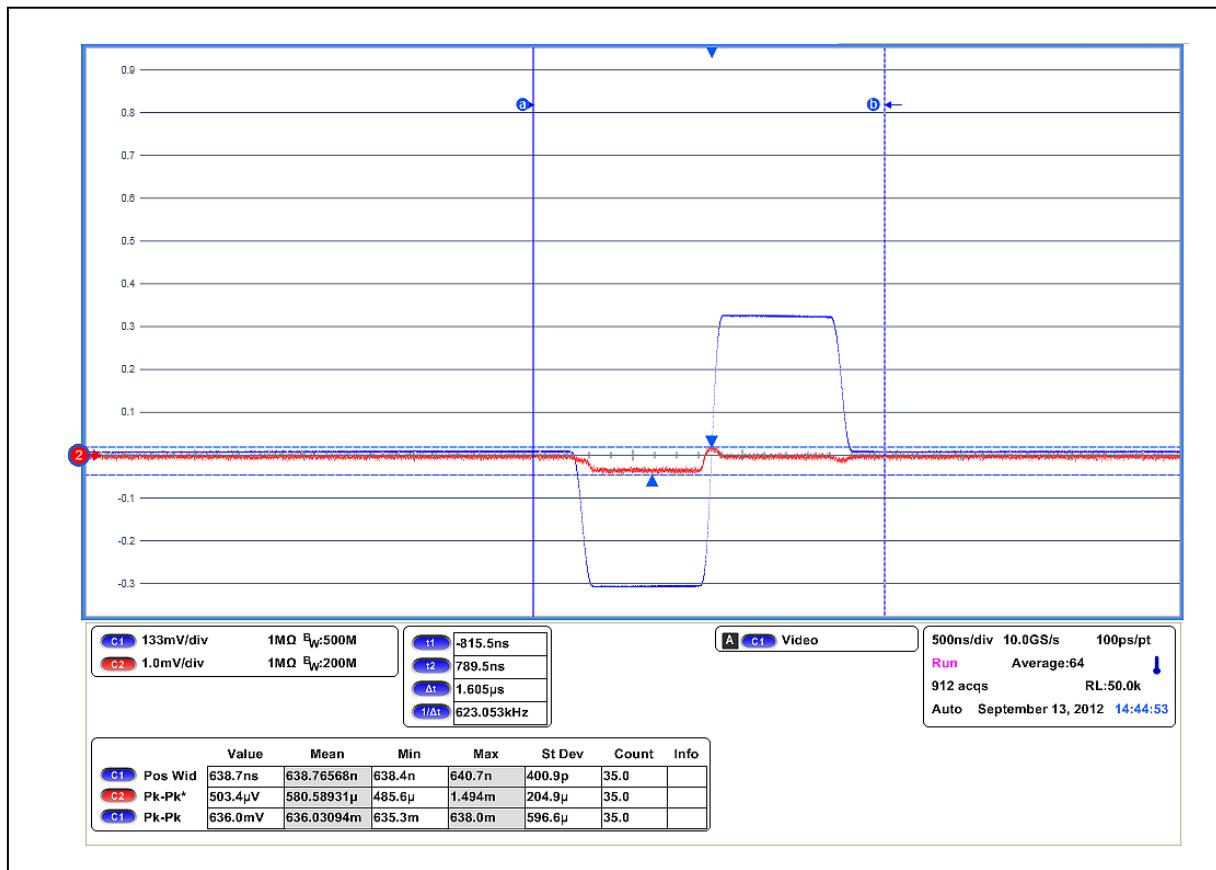
IO Input Leakage ( $I_O$ ) for  $I_{An}$ ,  $I_{Bn}$ ,  $Y_A$  and  $Y_B$ Switch ON Resistance ( $R_{ON}$ )

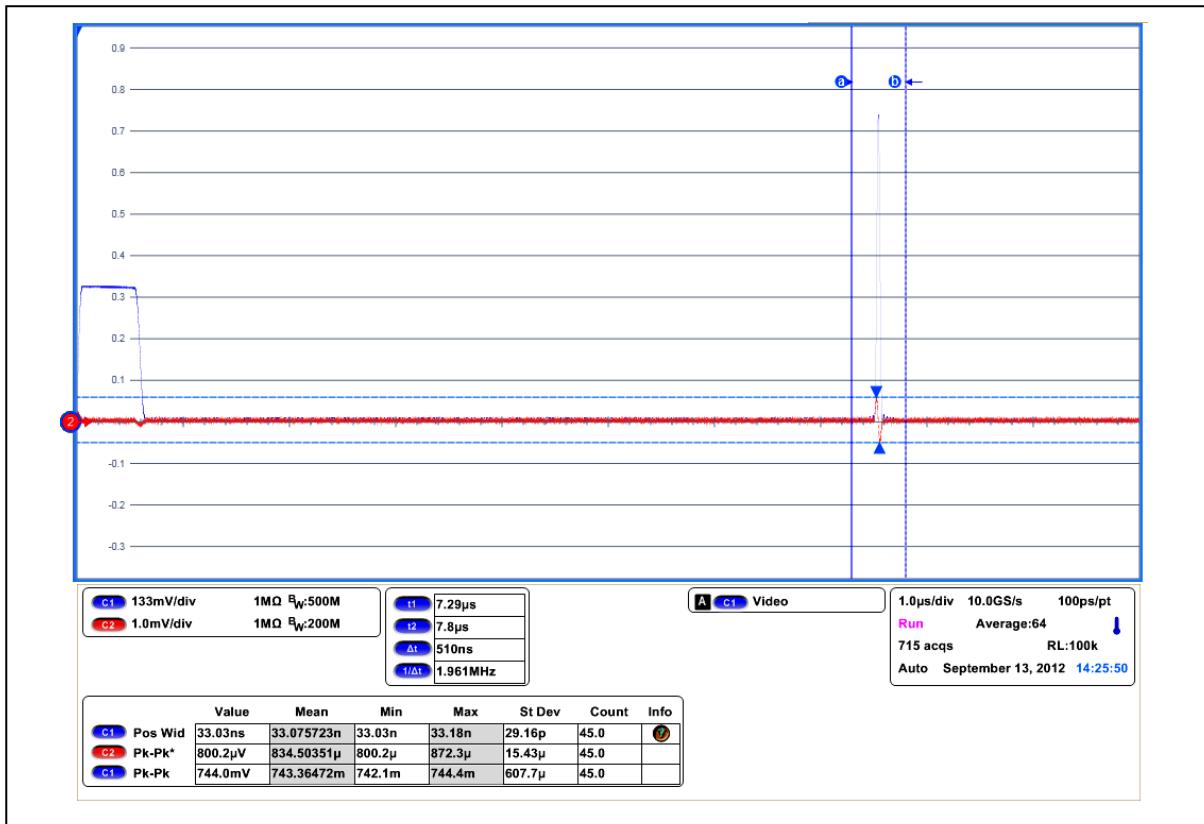
Input Logic Level ( $V_{IH}$ ,  $V_{IL}$ )

AC ELECTRICAL CHARACTERISTICSTurn ON/ Turn OFF Timing ( $T_{ON}$ ,  $T_{OFF}$ )

Bandwidth (-3dB Bandwidth, BW)

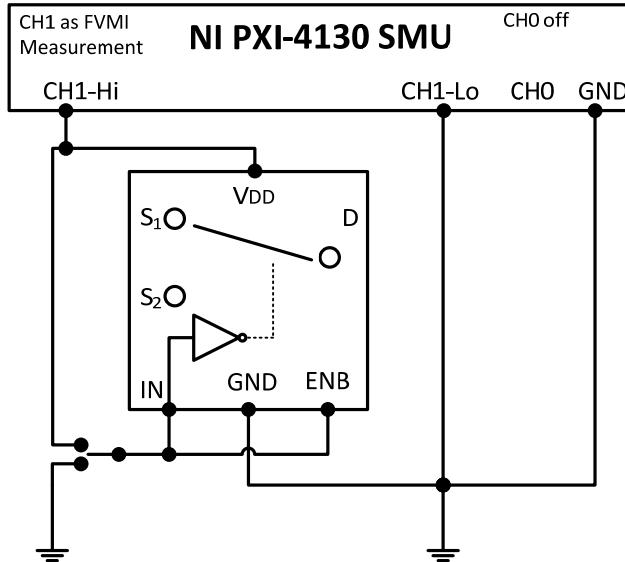


Differential Gain/ Phase (D<sub>G</sub>, D<sub>P</sub>)Video Off-Isolation (O<sub>ISO</sub>): Sync Feed Through

Video Off-Isolation ( $O_{ISO}$ ): 2T Pulse Feed Through

## Parameter Measurement Information

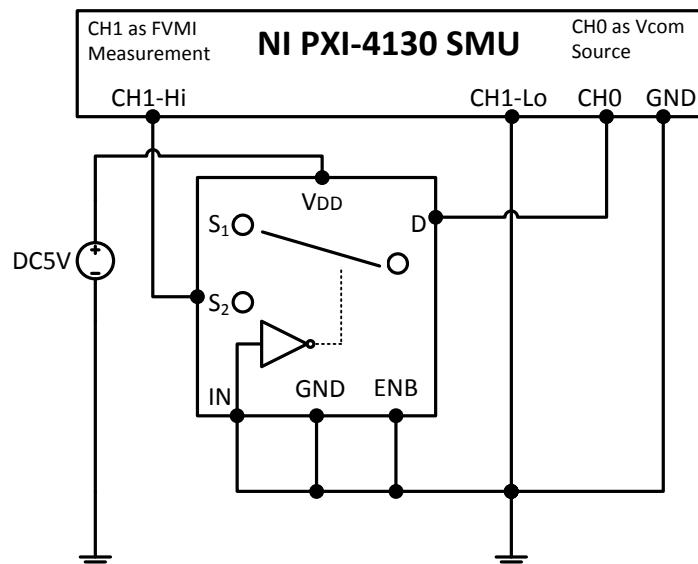
### Power Supply Current ( $I_{CC}$ )



### Quiescent Power Supply Current ( $V_{IN}=V_{DD}$ or GND)

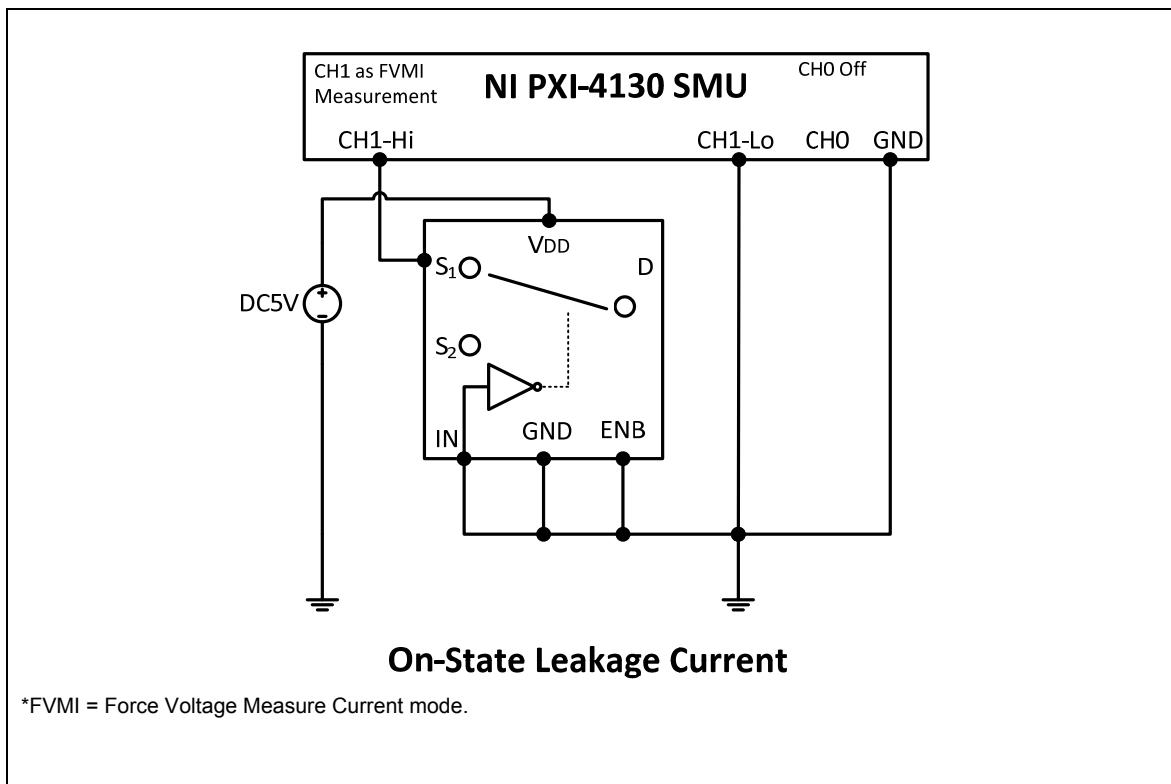
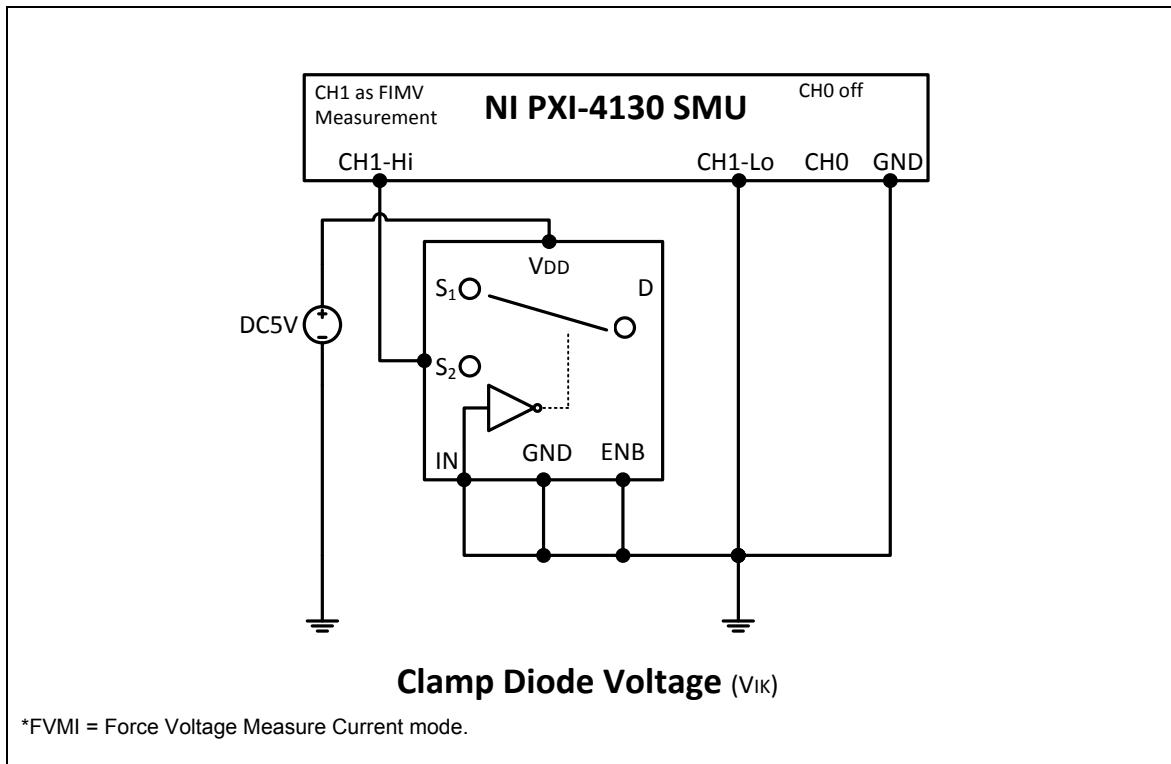
\*FVMI = Force Voltage Measure Current mode.

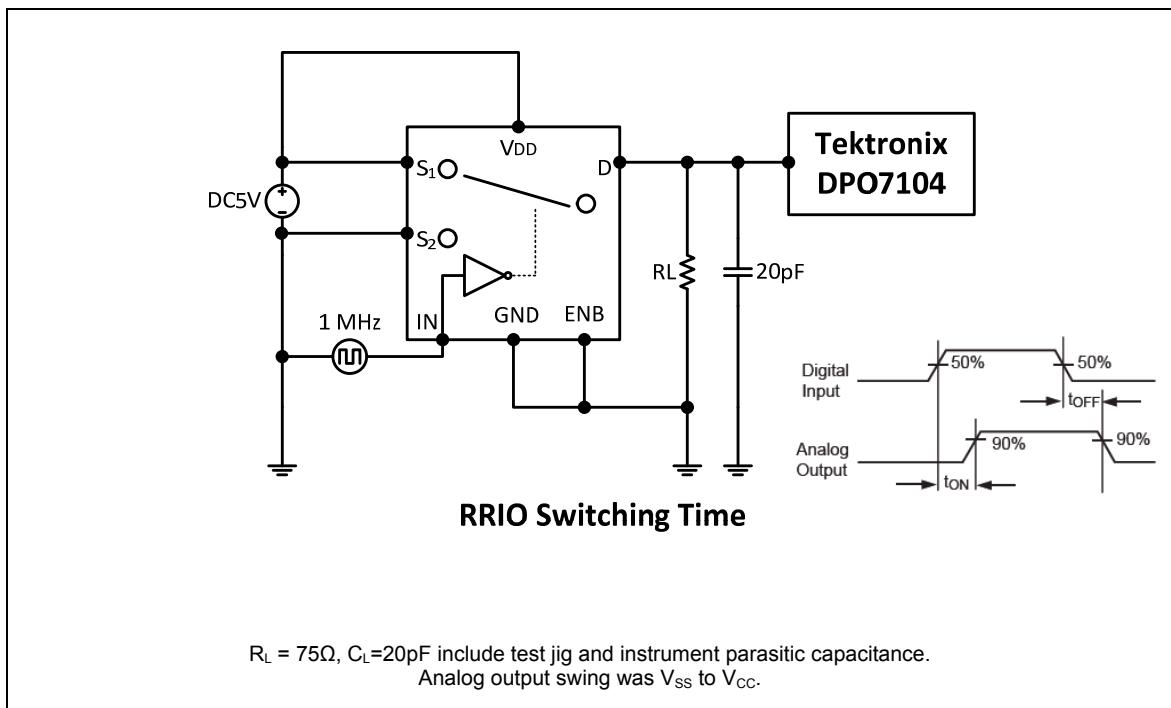
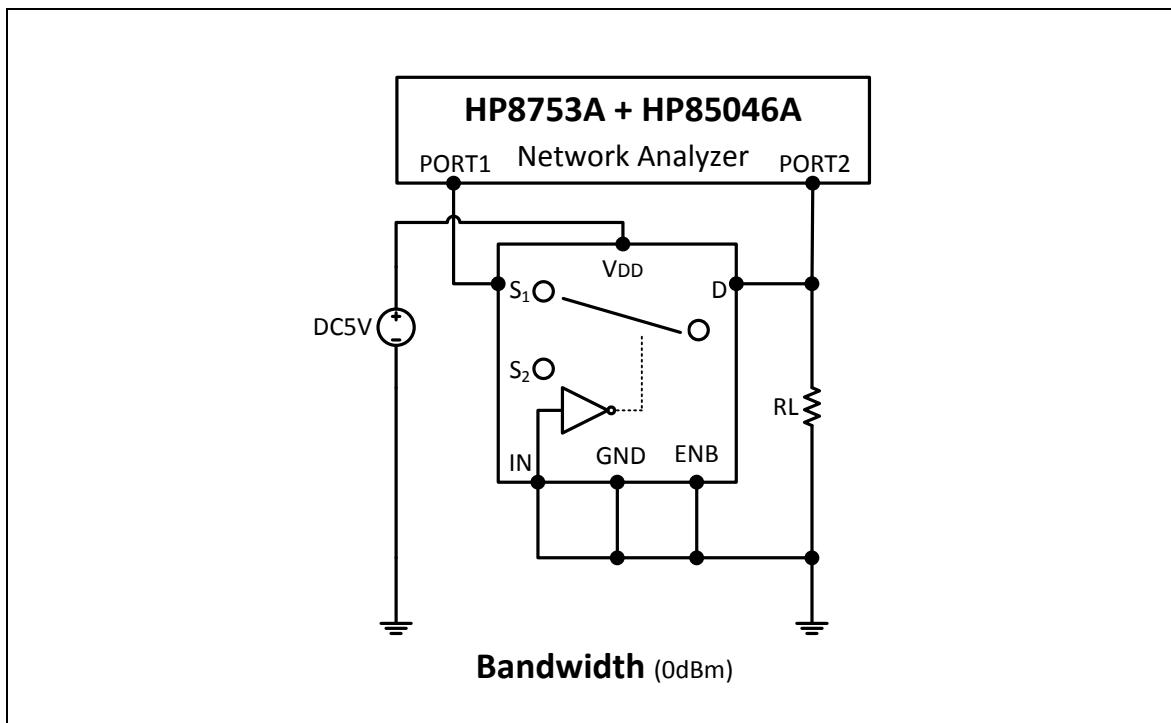
### Off-State Leakage Current ( $I_o$ )

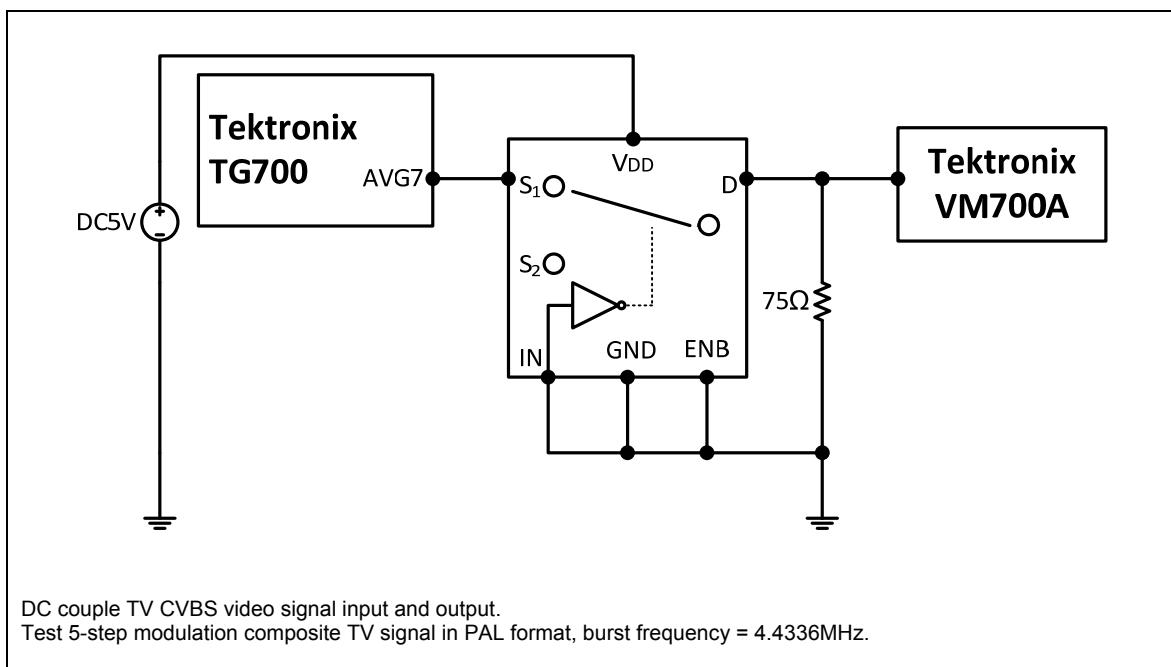
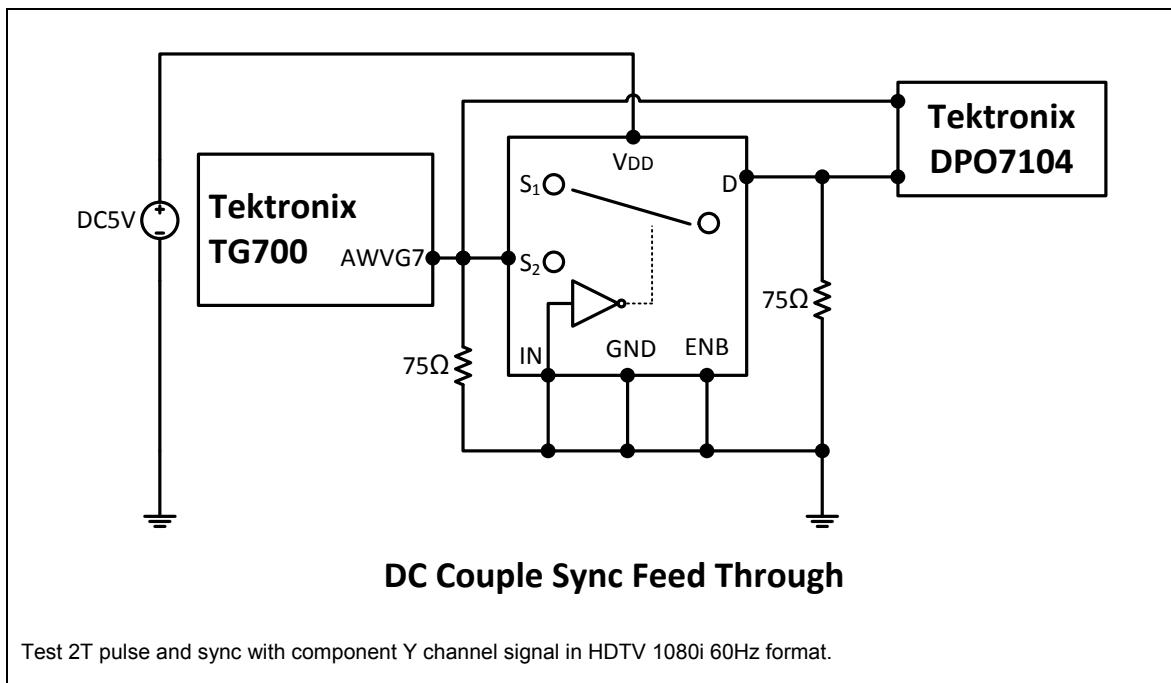


### Off-State Leakage Current

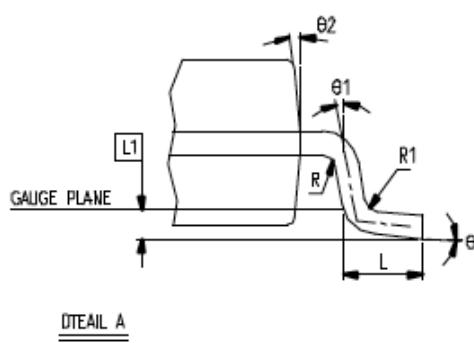
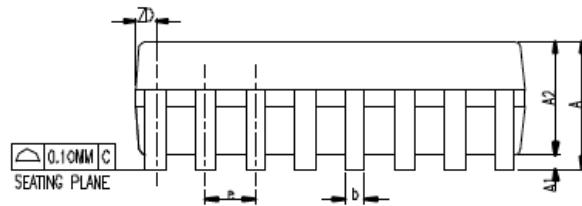
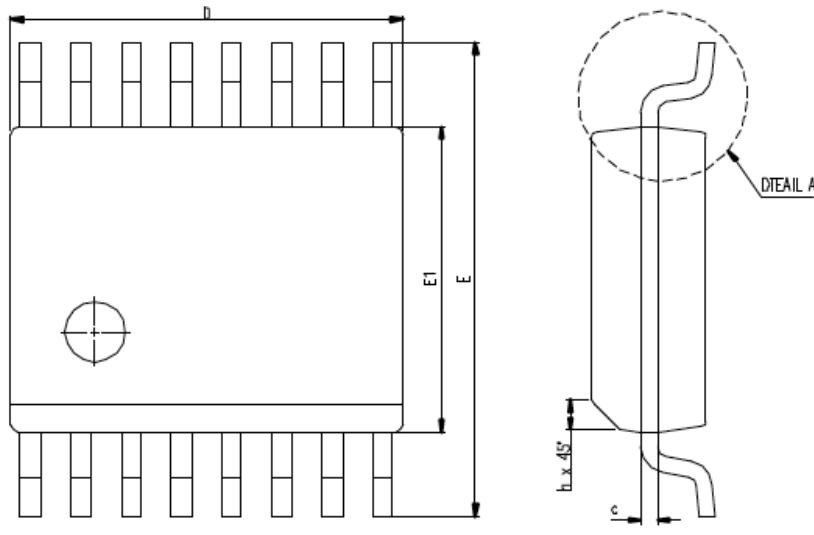
\*FVMI = Force Voltage Measure Current mode.

**On-State Leakage Current ( $I_o$ )****Clamp Diode Voltage ( $V_{IK}$ )**

**Rail to Rail Turn ON/Turn-OFF Timing ( $T_{ON}$ ,  $T_{OFF}$ )****Bandwidth (BW)**

**Differential Gain/ Phase ( $D_G$ ,  $D_P$ )****DC Couple Sync/ Pulse Feed-Through (Off-Isolation,  $O_{Iso}$ )**

**QSOP-16 MECHANICAL DATA**

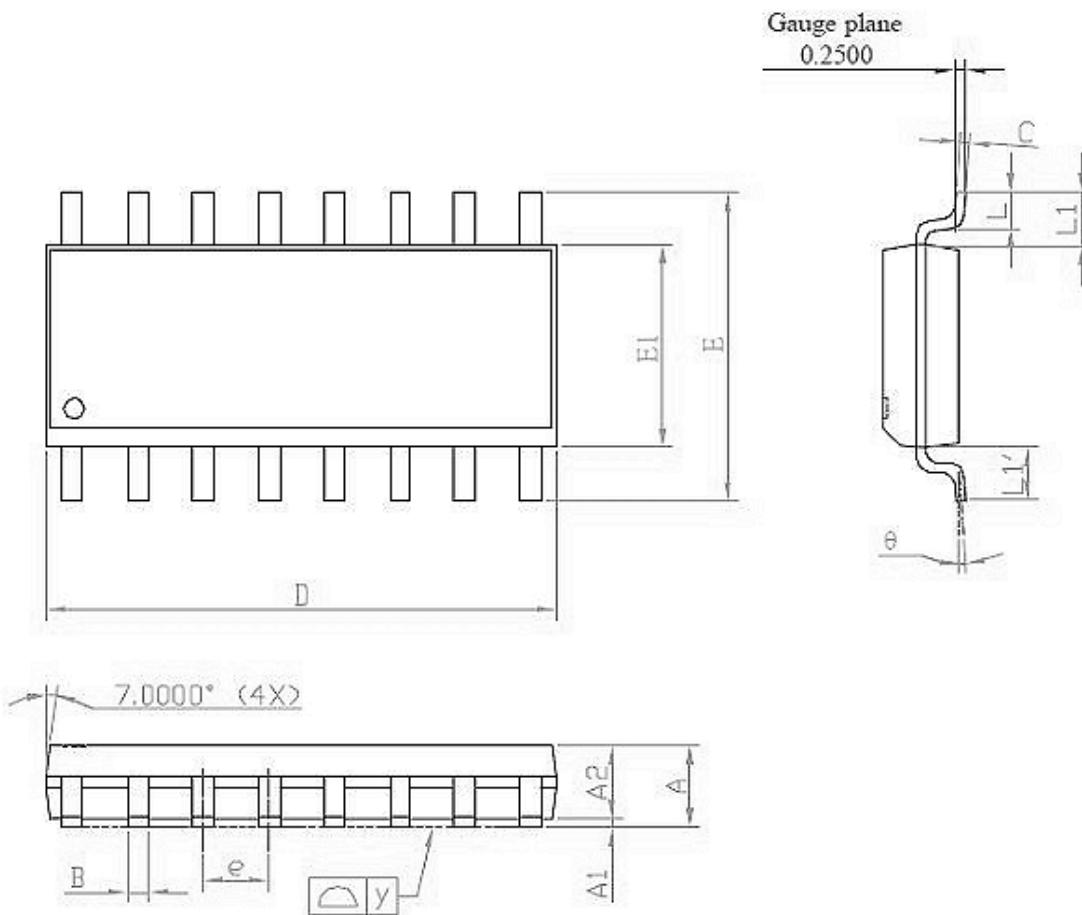


Symbol	Dimension in MM			Dimension in Inch		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.35	1.63	1.75	0.053	0.064	0.069
A1	0.10	0.15	0.25	0.004	0.006	0.010
A2			1.50			0.059
b	0.20		0.30	0.008		0.012
c	0.18		0.25	0.007		0.010
e	0.650 BASIC			0.025 BASEC		
D	4.80	4.90	5.00	0.189	0.193	0.197
E	5.79	5.99	6.20	0.228	0.236	0.244
E1	3.81	3.961	3.99	0.150	0.154	0.157
L	0.41	0.635	1.27	0.016	0.025	0.050
h	0.25		0.50	0.010		0.020
L1	0.254 BASIC			0.010 BASIC		
ZD	0.229 REF			0.009 REF		
R1	0.20		0.33	0.008		0.013
R	0.20			0.008		
θ	0*		8*	0*		8*
θ1	0*			0*		
θ2	5*	10*	15*	5*	10*	15*
JEDEC	MO-137 (AB)					

## Note:

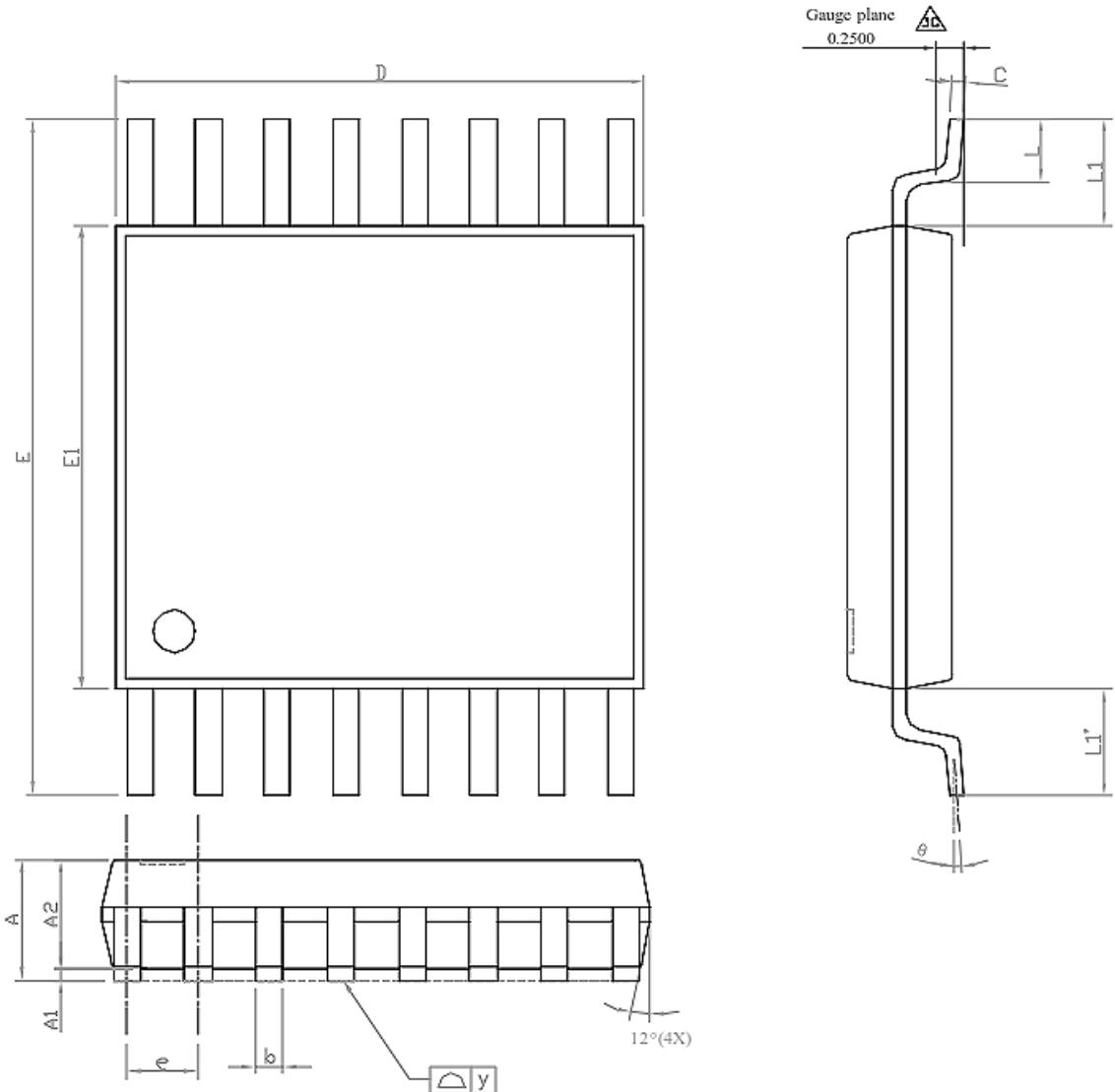
- Dimension 0 does not include mold protrusions or gate burrs
- Mold protrusions and gate burrs shall not exceed 0.006 inch per side.

## SOP-16 MECHANICAL DATA



Symbol	Dimension in MM			Dimension in Inch		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.35	1.60	1.75	0.053	0.063	0.069
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	9.80		10.00	0.386		0.394
E1	3.80	3.90	4.00	0.150		0.157
e		1.27				
E	5.80	6.00	3.20	0.228		0.244
L	0.40		1.27	0.016		0.050
y			0.10			0.004
Θ	0°		8°	0°		8°
L1-L1'			0.12			0.005
L1	1.04REF			0.041REF		

### TSSOP-16 MECHANICAL DATA



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.20	—	—	0.048
A1	0.05	—	0.15	0.002	—	0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19	—	0.30	0.007	—	0.012
C	0.09	—	0.20	0.004	—	0.008
D	4.90	5.00	5.10	0.193	0.197	0.201
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e	—	0.65	—	—	0.026	—
L	0.45	0.60	0.75	0.018	0.024	0.030
y	—	—	0.10	—	—	0.004
θ	0°	—	8°	0°	—	8°
$\Delta_A$	$ L1-L1' $		0.12	—	—	0.005
$\Delta_B$	L1 1.00REF			0.039REF		

## NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS
2. TOLERANCE  $\pm 0.1$  mm UNLESS OTHERWISE SPECIFIED
3. COPLANARITY: 0.1 mm
4. LEAD BURR LESS THAN 5 mil  $\Delta_A$
5. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
6. FOLLOWED TO JEDEC MO-153

|

Information furnished is believed to be accurate and reliable. However, SAVITECH assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties that may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SAVITECH. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SAVITECH products are not authorized for use as critical components in life support devices or systems without express written approval of SAVITECH.

The SAVITECH logo is a registered trademark of Savitech Corporation.

All other names are the property of their respective owners

© 2011 Savitech Corporation - All Rights Reserved